# Advance Information

# **Inverter with Open Drain Output**

The MC74VHC1G05 is an advanced high speed CMOS inverter with open drain output fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

The internal circuit is composed of three stages, including an open drain output which provides the capability to set output switching level. This allows the MC74VHC1G05 to be used to interface 5V circuits to circuits of any voltage between V<sub>CC</sub> and 7V using an external resistor and power supply.

The MC74VHC1G05 input structure provides protection when voltages up to 7V are applied, regardless of the supply voltage.

- High Speed: tpD = 3.8 ns (Typ) at VCC = 5V
- Low Internal Power Dissipation:  $I_{CC} = 2\mu A$  (Max) at  $T_A = 25^{\circ}C$
- Power Down Protection Provided on Inputs
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300mA
- ESD Performance: HBM > 2000V; MM > 200V, CDM > 1500V

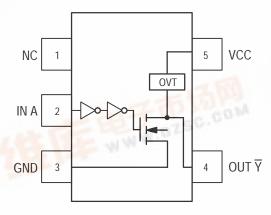


Figure 1. 5-Lead SOT-353 Pinout (Top View)

# LOGIC SYMBOL



This document contains information on a new product. Specifications and information herein are subject to change without notice.



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SC-88A / SOT-353 DF SUFFIX CASE 419A

#### MARKING DIAGRAM



Pin 1

d = Date Code

	PIN ASSIGNMENT							
1-1-	NC							
2	IN A							
3	GND							
4	OUT $\overline{Y}$							
5	VCC							

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

#### **FUNCTION TABLE**

A Input	Y Output
L	Z
Н	L

# **MAXIMUM RATINGS\***

Characteristics	Symbol	Value	Unit
DC Supply Voltage	Vcc	-0.5 to +7.0	V
DC Input Voltage	VIN	-0.5 to +7.0	V
DC Output Voltage	Vout	-0.5 to 7.0	V
Input Diode Current	ΙΙΚ	-20	mA
Output Diode Current (V <sub>OUT</sub> < GND; V <sub>OUT</sub> > V <sub>CC</sub> )	lok	+20	mA
DC Output Current, per Pin	lout	+25	mA
DC Supply Current, V <sub>CC</sub> and GND	Icc	+50	mA
Power dissipation in still air, SC-88A †	PD	200	mW
Lead temperature, 1 mm from case for 10 s	TL	260	°C
Storage temperature	T <sub>stg</sub>	-65 to +150	°C

<sup>\*</sup> Maximum Ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute—maximum—rated conditions is not implied. Functional operation should be restricted to the Recommended Operating Conditions.

# **RECOMMENDED OPERATING CONDITIONS**

Characteristics	Symbol	Min	Max	Unit
DC Supply Voltage	Vcc	2.0	5.5	V
DC Input Voltage	VIN	0.0	5.5	V
DC Output Voltage	Vout	0.0	7.0	V
Operating Temperature Range	T <sub>A</sub>	<b>-</b> 55	+85	°C
Input Rise and Fall Time $V_{CC} = 3.3V \pm 0.3V$ $V_{CC} = 5.0V \pm 0.5V$	t <sub>r</sub> , t <sub>f</sub>	0 0	100 20	ns/V

<sup>†</sup>Derating — SC-88A Package:  $-3 \text{ mW}/^{\circ}\text{C}$  from  $65^{\circ}$  to  $125^{\circ}\text{C}$ 

# DC ELECTRICAL CHARACTERISTICS

			VCC	Т	A = 25°0	C	T <sub>A</sub> ≤	85°C	<b>T</b> <sub>A</sub> ≤ 125°C		
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Max	Min	Max	Unit
VIH	Minimum High–Level Input Voltage		2.0 3.0 4.5 5.5	1.5 2.1 3.15 3.85			1.5 2.1 3.15 3.85		1.5 2.1 3.15 3.85		V
V <sub>IL</sub>	Maximum Low–Level Input Voltage		2.0 3.0 4.5 5.5			0.5 0.9 1.35 1.65		0.5 0.9 1.35 1.65		0.5 0.9 1.35 1.65	V
VOH	Minimum High-Level Output Voltage VIN = VIH or VIL	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -50 \mu A$	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5		1.9 2.9 4.4		1.9 2.9 4.4		V
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OH</sub> = -4mA I <sub>OH</sub> = -8mA	3.0 4.5	2.58 3.94			2.48 3.80		2.34 3.66		V
V <sub>OL</sub>	Maximum Low–Level Output Voltage VIN = VIH or VIL	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OL</sub> = 50μA	2.0 3.0 4.5		0.0 0.0 0.0	0.1 0.1 0.1		0.1 0.1 0.1		0.1 0.1 0.1	V
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OL</sub> = 4mA I <sub>OL</sub> = 8mA	3.0 4.5			0.36 0.36		0.44 0.44		0.52 0.52	V
IIN	Maximum Input Leakage Current	V <sub>IN</sub> = 5.5V or GND	0 to 5.5			±0.1		±1.0		±1.0	μА
ICC	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5			2.0		20		40	μΑ
lopd	Maximum Off–state Leakage Current	V <sub>OUT</sub> = 5.5V	0			0.25		2.5		5.0	μΑ

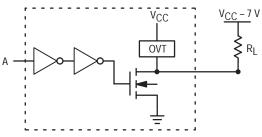
# AC ELECTRICAL CHARACTERISTICS (Cload = 50 pF, Input $t_{\Gamma}$ = $t_f$ = 3.0ns)

·					A = 25°0		T <sub>A</sub> ≤	85°C	T <sub>A</sub> ≤	125°C	
Symbol	Parameter	Test Condition	ıs	Min	Тур	Max	Min	Max	Min	Max	Unit
<sup>t</sup> PZL	Maximum Output Enable Time,	V <sub>CC</sub> = 3.0 ± 0.3V	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		5.0 7.5	7.1 10.6		8.5 12.0		10.0 14.5	ns
	Input A to $\overline{Y}$	V <sub>CC</sub> = 5.0 ± 0.5V	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		3.8 5.3	5.5 7.5		6.5 8.5		8.0 10.0	
t <sub>PLZ</sub>	Maximum Output	$V_{CC} = 3.0 \pm 0.3 \text{V}, R_L = 1 \text{K}$	$\Omega$ , $C_L = 50 pF$		7.5	10.6		12.0		14.5	ns
Disable Time		$V_{CC} = 5.0 \pm 0.5 \text{V}, R_L = 1 \text{K}$	$\Omega$ , $C_L = 50 pF$		5.3	7.5		8.5		10.0	
C <sub>IN</sub>	Maximum Input Capacitance				4	10		10		10	pF

		Typical @ 25°C, V <sub>CC</sub> = 5.0V	
C <sub>PD</sub>	Power Dissipation Capacitance (Note 1.)	18	pF

<sup>1.</sup> CpD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: ICC(OPR) = CpD • VCC • f<sub>in</sub>+ICC. CpD is used to determine the no–load dynamic power consumption; PD = CpD • VCC<sup>2</sup> • f<sub>in</sub>+ICC • VCC.

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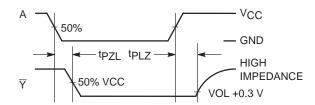
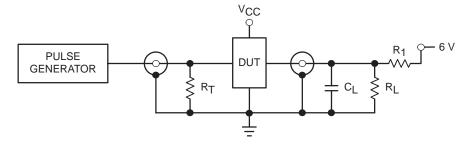


Figure 2. Output Voltage Mismatch Application

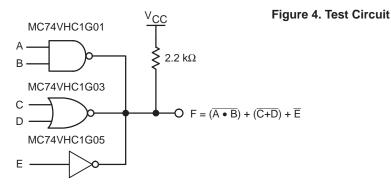
Figure 3. Switching Waveforms



 $C_L = 50 \text{ pF}$  equivalent (Includes jig and probe capacitance)

 $R_L = R_1 = 500 \Omega$  or equivalent

 $R_T = Z_{OUT}$  of pulse generator (typically 50  $\Omega$ )



VCC VCC 1 5 R LED

Figure 5. Complex Boolean Functions

MC74VHC1G05 Figure 6. LED Driver

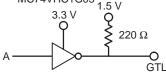


Figure 7. GTL Driver

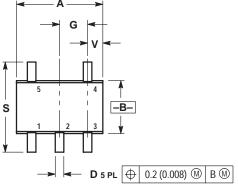
# **DEVICE ORDERING INFORMATION**

	Device Nomenclature							
Device Order Number	Circuit Indicator	Temp Range Identifier	Technology	Device Function	Package Suffix	Tape & Reel Suffix	Package Type	Tape and Reel Size
MC74VHC1G05DFT1	MC	74	VHC1G	05	DF	T1	SC-88A / SOT-353	7–Inch/3000 Unit

# **PACKAGE DIMENSIONS**

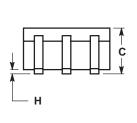
SC-88A / SOT-353 **DF SUFFIX** 5-LEAD PACKAGE CASE 419A-01

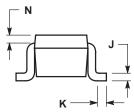
ISSUE B

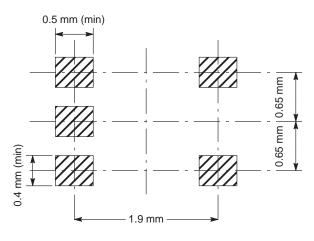


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MM.

	INC	HES	MILLIN	IETERS
DIM	MIN	MIN MAX		MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
С	0.031	0.043	0.80	1.10
D	0.004	0.012 0.10		0.30
G	0.026	BSC	0.65	BSC
Н		0.004		0.10
٦	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008	REF	0.20	REF
S	0.079	0.087	2.00	2.20
٧	0.012	0.016	0.30	0.40







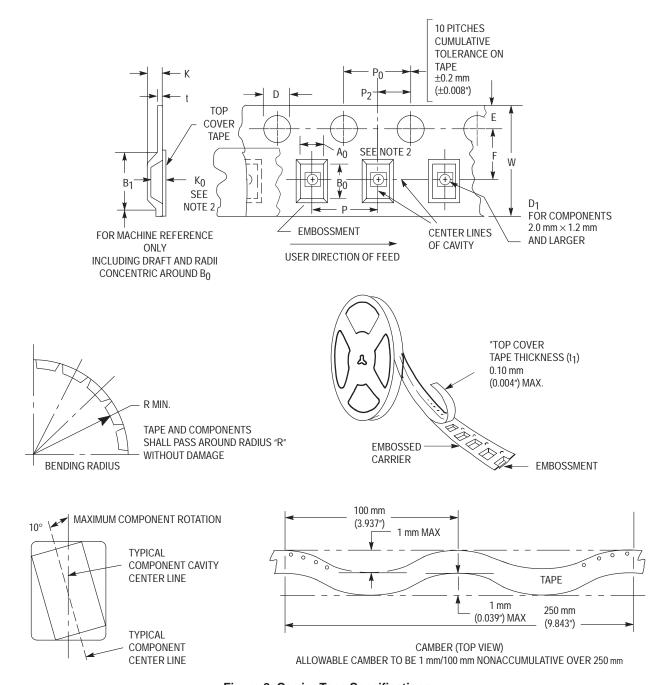


Figure 8. Carrier Tape Specifications

# EMBOSSED CARRIER DIMENSIONS (See Notes 1 and 2)

Tape Size	B <sub>1</sub> Max	D	D <sub>1</sub>	E	F	К	Р	P <sub>0</sub>	P <sub>2</sub>	R	Т	w
8 mm	4.35 mm (0.171")	1.5 +0.1/ -0.0 mm (0.059 +0.004/ -0.0")	1.0 mm Min (0.039")	1.75 ±0.1 mm (0.069 ±0.004")	3.5 ±0.5 mm (1.38 ±0.002")	2.4 mm (0.094")	4.0 ±0.10 mm (0.157 ±0.004")	4.0 ±0.1 mm (0.156 ±0.004")	2.0 ±0.1 mm (0.079 ±0.002")	25 mm (0.98")	0.3 ±0.05 mm (0.01 +0.0038/ -0.0002")	8.0 ±0.3 mm (0.315 ±0.012")

<sup>1.</sup> Metric Dimensions Govern-English are in parentheses for reference only.

<sup>2.</sup> A<sub>0</sub>, B<sub>0</sub>, and K<sub>0</sub> are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min to 0.50 mm max. The component cannot rotate more than 10° within the determined cavity

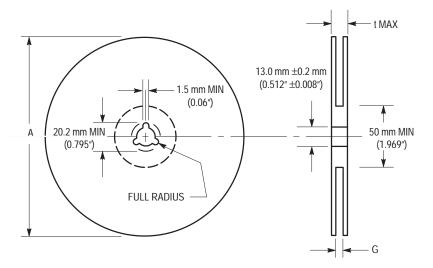


Figure 9. Reel Dimensions

# **REEL DIMENSIONS**

Tape Size	A Max	G	t Max
8 mm	330 mm	8.400 mm, +1.5 mm, -0.0	14.4 mm
	(13")	(0.33", +0.059", -0.00)	(0.56")

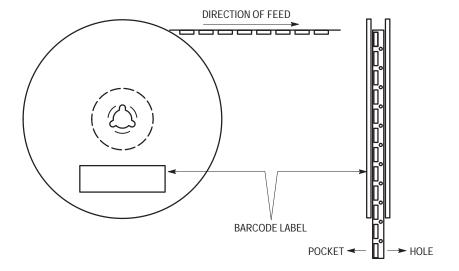


Figure 10. Reel Winding Direction

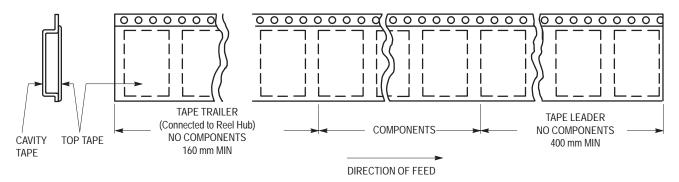


Figure 11. Tape Ends for Finished Goods

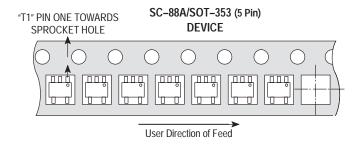


Figure 12. Reel Configuration

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